WHAT IS CLAIMED IS:

- A method of manufacturing a probe comprising a cantilever beam, a probe tip and a contact area, said method
 comprising the steps of:
 - etching a substrate using a first patterned masking layer as an etch mask, said etching creating a mould in said substrate;
- depositing a first layer on said mould and on said
 patterned masking layer;
 - patterning said first layer to form the probe tip;
 - partially under-etching the probe tip using said patterned first layer as a hard mask; and
- peeling off the probe tip from the underlying first patterned masking layer.
 - 2. The method as recited in Claim 1, further comprising the step of using said patterned first layer as a mask to remove said first patterned masking layer.
- The method as recited in Claim 1, further
 comprising the step of selectively depositing at least one additional layer on said patterned first layer.
 - 4. The method as recited in Claim 4, wherein said first layer comprises a metal, and wherein said step of selectively depositing comprises the step of plating.
- 5. The method as recited in Claim 5, wherein said first layer comprises Ti, W and Au and said additional layer comprises Ni.
 - 6. The method as recited in Claim 1, further comprising the steps of:
- temporarily spacing apart a substantial part of said probe tip and said underlying first patterned masking layer; and
 attaching a holder chip to said contact area.

- 7. The method as recited in Claim 1, wherein said partially under-etching of said probe tip under-etches at least the probe tip.
- 8. The method as recited in Claim 1, wherein said partially under-etching of said probe tip under-etches at least the probe tip and the cantilever beam.
 - 9. The method as recited in Claim 1, further comprising the steps of:
- depositing a second layer on said mould and on said first .0 patterned masking layer; and
 - patterning said second layer to form the probe tip.
 - 10. The method as recited in Claim 9, wherein said first and said second layers comprise substantially the same material.
- 15 11. The method as recited in Claim 10, wherein said material comprises Ti, W and Au.
 - 12. The method as recited in Claim 9, wherein said first and said second layers comprise substantially different material.
- 20 13. The method as recited in Claim 12, wherein said first layer comprises Ti, W and Au and said second layer comprises Cr or Diamond.
 - 14. The method as recited in Claim 9, further comprising the step of annealing.
- 25 15. The method as recited in Claim 1, wherein said substrate comprises silicon.
 - 16. The method as recited in Claim 1, wherein said first patterned masking layer comprises one of oxides, nitrides, and oxynitrides.
- 17. A probe comprising a cantilever beam, a probe tip and a contact area, the probe being manufactured by a method comprising the steps of:

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- etching a substrate using a first patterned masking layer as an etch mask, said etching creating a mould in said substrate;
- depositing a first layer on said mould and on saidpatterned masking layer;
 - patterning said first layer to form the probe tip;
 - partially under-etching the probe tip using said patterned first layer as a hard mask; and
- peeling off the probe tip from the underlying firstpatterned masking layer.
 - 18. The probe as recited in Claim 17, wherein the method further comprises:
 - depositing a second layer on said mould and on said first patterned masking layer; and
- 15 patterning said second layer to form the probe tip.
 - 19. A system for manufacturing a probe, the system comprising:
 - means for etching a substrate using a first patterned masking layer as an etch mask, said etching means creating a mould in said substrate;
 - means for depositing a first layer on said mould and on said patterned masking layer;
 - means for patterning said first layer to form a probe tip;
- means for partially under-etching the probe tip using said

 25 patterned first layer as a hard mask; and
 - means for peeling off the probe tip from the underlying first patterned masking layer.
 - 20. The system as recited in Claim 19, further comprising:
- 30 means for depositing a second layer on said mould and on said first patterned masking layer; and

- means for patterning said second layer to form the probe tip.